


| Government eProcurement System | | eProcurement System Government of India | |
|---|---------------------------------|--|---|
| Tender Details | | Date : 08-Aug-2023 09:36 AM | |
|  Print | | | |
| Basic Details | | | |
| Organisation Chain | Semi-Conductor Laboratory (SCL) | | |
| Tender Reference Number | SCL/PS/44927/B-21/2023 | | |
| Tender ID | 2023_SCL_765701_1 | Withdrawal Allowed | Yes |
| Tender Type | Global Tenders | Form of contract | Supply |
| Tender Category | Goods | No. of Covers | 2 |
| General Technical Evaluation Allowed | No | ItemWise Technical Evaluation Allowed | No |
| Payment Mode | Offline | Is Multi Currency Allowed For BOQ | Yes |
| Is Multi Currency Allowed For Fee | No | Allow Two Stage Bidding | No |
| Payment Instruments | | Cover Details, No. Of Covers - 2 | |
| Offline | S.No | Instrument Type | Cover No |
| | 1 | Bankers Cheque | Cover |
| | 2 | Bank Guarantee | Document Type |
| | 3 | Demand Draft | Description |
| | 4 | FDR | 1 |
| | | | Fee/PreQual/Technical .pdf |
| | | | .pdf |
| | | | .pdf |
| | | | .pdf |
| | | | .pdf |
| | 2 | Finance | .xls |
| | | | .pdf |
| | | | Invitation to Tender Acceptance Letter |
| | | | Compliance to Commercial Terms and Conditions |
| | | | Compliance to Specifications And Drawings |
| | | | Scanned and Signed copy of EMD |
| | | | Other Documents if any |
| | | | BOQ |
| | | | Signed and Scanned copy of BOQ |
| Tender Fee Details, [Total Fee in ₹ * - 0.00] | | EMD Fee Details | |
| Tender Fee in ₹ | 0.00 | EMD Amount in ₹ | 1,50,000 |
| Fee Payable To | Nil | EMD through BG/ST or EMD Exemption Allowed | Yes |
| Fee Payable At | Nil | EMD Fee Type | fixed |
| Tender Fee Exemption Allowed | No | EMD Percentage | NA |
| | | EMD Payable To | Semi-Conductor Laboratory (SCL) |
| | | EMD Payable At | Semi-Conductor Laboratory (SCL) |
| Click to view modification history | | | |
| Foreign Currency BOQ Details | | | |

| S.No | Currency | Conversion rate in ₹ |
|------|------------------|----------------------|
| 1 | US Dollar | NA |
| 2 | European Euro | NA |
| 3 | British Pound | NA |
| 4 | Japanese yen | NA |
| 5 | Singapore Dollar | NA |

| Work /Item(s) | | | | | |
|--------------------------------------|------------------------------------|---------------------------|-----------------------------------|-----------------------|---------------------------|
| Title | Supply of Sealing Lid with Preform | | | | |
| Work Description | Supply of Sealing Lid with Preform | | | | |
| Pre Qualification Details | Please refer Tender documents. | | | | |
| Independent External Monitor/Remarks | NA | | | | |
| Show Tender Value in Public Domain | No | | | | |
| Tender Value in ₹ | 0.00 | Product Category | Electronic Components And Devices | Sub category | NA |
| Contract Type | Tender | Bid Validity(Days) | 120 | Period Of Work (Days) | 90 |
| Location | Semi Conductor Laboratory | Pincode | 160071 | Pre Bid Meeting Place | NA |
| Pre Bid Meeting Address | NA | Pre Bid Meeting Date | NA | Bid Opening Place | Semi Conductor Laboratory |
| Should Allow NDA Tender | No | Allow Preferential Bidder | No | | |

| Critical Dates | | | |
|-------------------------------------|----------------------|-----------------------------------|----------------------|
| Publish Date | 07-Aug-2023 06:00 PM | Bid Opening Date | 05-Sep-2023 12:00 PM |
| Document Download / Sale Start Date | 07-Aug-2023 06:00 PM | Document Download / Sale End Date | 04-Sep-2023 12:00 PM |
| Clarification Start Date | 07-Aug-2023 06:00 PM | Clarification End Date | 14-Aug-2023 10:00 AM |
| Bid Submission Start Date | 14-Aug-2023 11:00 AM | Bid Submission End Date | 04-Sep-2023 12:00 PM |

| Tender Documents | | | | |
|---------------------|------|--------------------|-----------------|-----------------------|
| NIT Document | S.No | Document Name | Description | Document Size (in KB) |
| | 1 | Tendernotice_1.pdf | Tender Document | 555.31 |
| Work Item Documents | S.No | Document Type | Document Name | Description |
| | 1 | BOQ | BOQ_804914.xls | BOQ |

| Auto Extension Corrigendum Properties for Tender | | |
|--|---|-------------------------------------|
| Iteration | No. of bids required for bid opening a tender | Tender gets extended to No. of days |
| 1. | 3 | 10 |
| 2. | 3 | 7 |
| 3. | 3 | 5 |

| Bid Openers List | | | |
|------------------|---------------------|-----------------|------------------|
| S.No | Bid Opener Login Id | Bid Opener Name | Certificate Name |
| 1. | abudhwar@scl.gov.in | Anil Budhwar | ANIL BUDHWAR |

| | | | |
|----|--------------------------|---------------------|---------------------|
| 2. | punit@scl.gov.in | Punit Kumar | PUNIT KUMAR |
| 3. | ashutosh.gaur@scl.gov.in | Ashutosh Singh Gaur | ASHUTOSH SINGH GAUR |
| 4. | vmehta@scl.gov.in | Varinder Mehta | VARINDER MEHTA |

GeMARPTS Details

| | |
|----------------------------|--|
| GeMARPTS ID | LP49WWV8L61A |
| Description | Sealing Lid with Preform LWP OD 1170 mils x 1170 mils and ID 1093 mils x 1093 mils |
| Report Initiated On | 04-Aug-2023 |
| Valid Until | 03-Sep-2023 |

Tender Properties

| | | | |
|--|-----------------------|---|-----|
| Auto Tendering Process allowed | No | Show Technical bid status | Yes |
| Show Finance bid status | Yes | Show Bids Details | No |
| BoQ Comparative Chart model | Normal | BoQ Compative chart decimal places | 2 |
| BoQ Comparative Chart Rank Type | L | Form Based BoQ | No |
| Show Bid Details in Public Domain stage | Technical Bid Opening | | |

GEM/TIA Undertaking

| S.No | Undertaking | Mandatory | Status | Remarks |
|------|--------------------|-----------|--------|---------------------------|
| 1 | PPP-MII Order 2017 | No | Agreed | According to DPIIT orders |
| 2 | MSEs Order 2012 | Yes | Agreed | |

Tender Inviting Authority

| | |
|----------------|---------------------------|
| Name | Anil Budhwar |
| Address | Semi Conductor Laboratory |

Tender Creator Details

| | |
|---------------------|----------------------|
| Created By | Varinder Mehta |
| Designation | Sr Assistant |
| Created Date | 07-Aug-2023 12:14 PM |